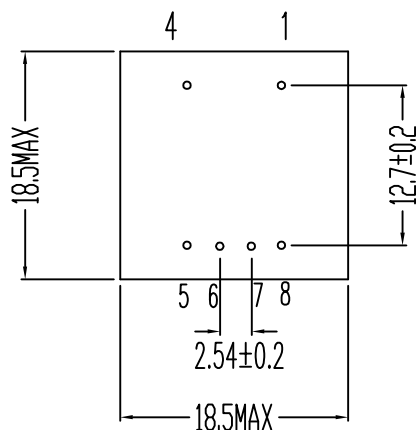
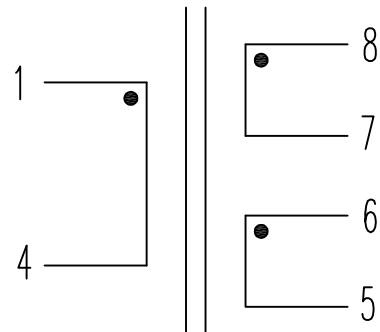
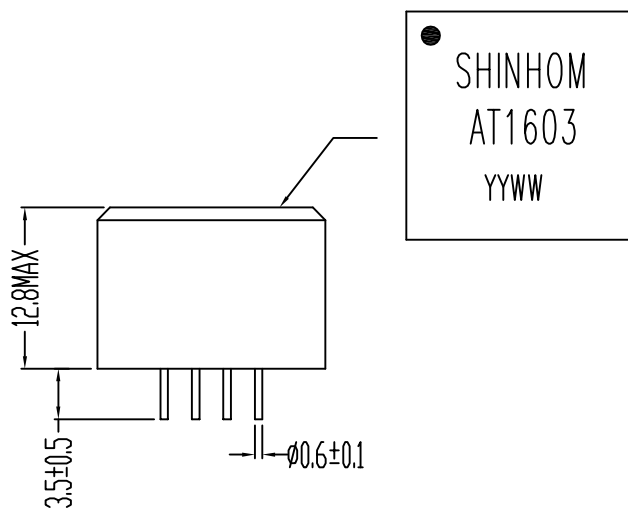




ELECTRICAL CHARACTERISTICS:

1.DCR:

PIN1-4=66 OHM $\pm 10\%$,

PIN5-8=66 OHM $\pm 10\%$,

2.PARALLEL INDUCTANCE:200Hz,1V

PIN1-4=5-8=2.8H MIN

3.IMPEDANCE:(1KHz,1V,W/H 600 OHM LOAD) =600 OHM $\pm 22\%$

4.INSERTION LOSS:(2KHz,1V,W/H 600 OHM LOAD) =1.5dB MAX

5.RETURN LOSS:(REF 600 OHM)

@200Hz=18dB MIN

@1KHz=18dB MIN

@4KHz=12dB MIN

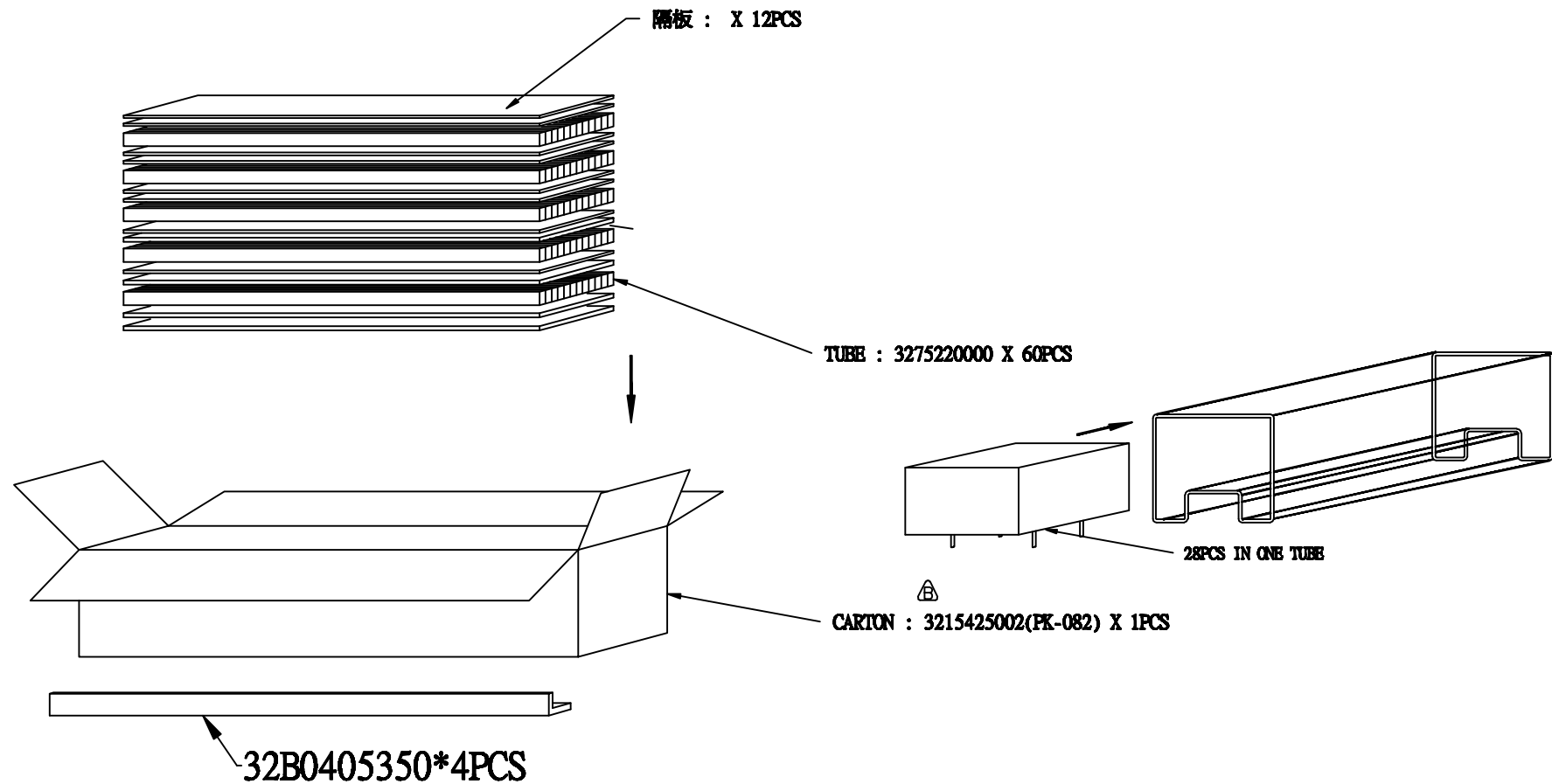
6.TURN RATIO:10KHz,1V

PIN1-4:8-5=1 $\pm 2\%$

7.HI-POT: 4000vAC 1mA 60SEC:P-S

8.ROHS COMPLIANT

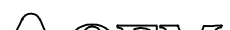
							TITLE	
							DRAWING	
							DWG.NO	
							ATSE-510R	
	RELEASE		12/12/2012	Zhao	Fang	Wang	UNITS	SAFETY
							M/M	
NO:	DESCRIPTION		DATE	BY	CHK	APPD	DATE	SHEET 1 OF 1
REVISIONS							P/N	DRAW
							12/12/2012	赵泉州



每捲放乾燥包 1pc 放入塑膠袋反折.再放入紙箱

△ 紙箱外四陵角處用4PCS(32B0405350)做保護

ONE CARTON：1680 PCS

C	CHANTGE PACKING	08/25/2022	SHIRLEY	TINA	TINA		TITLE	
B	CHANGTGE PART NO.	03/05/2012	SHIRLEY	JOAN	JOAN		DWG. NO.	
A	CHANGE 隔板						9681003L00	
	RELEASE	05/24/2006	PAIR			UNITS: M/M	SAFETY	SHEET 1 OF 1
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE		DRAW
REVISIONS								



Resistance to soldering heat (wave soldering)



Resistance to soldering heat (wave soldering) referring to the terminals

Key	Par.	Profile feature	Pb free Process
T.1	T _{sb}	Final Preheat Temperature	150°C
T.2	t pre-heat	Pre-heating time (T room to T _{sb})	180sec
T.3	d _T /d _t up	Ramp-Up Rate (T _{sb} to T _p)	180°C/sec
T.4	T _p	Peak Temperature T _p	255°C ~ 265°C
T.5	t contact	Contact Time at Peak	10sec (5sec x wave)
T.6	d _T /d _t down	Ramp-Down Rate	5°C/sec
Failure criteria concerning quality of the soldering termination acc. to the IPC-A-610D			